

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	314	((tube WITH (conduct \$5)) SAME solder\$3) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 13:55
L2	180	((tube WITH (conduct \$5)) SAME (tube WITH solder\$3)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 13:57
L3	85	((tube NEAR8 (conduct\$5)) SAME (tube NEAR8 solder \$3)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:02
L4	18	((tube NEAR8 (conduct\$5)) SAME (tube NEAR8 solder \$3)) AND ((in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:05
L5	18	((tube NEAR8 (conduct\$5)) SAME (tube NEAR8 solder \$3)) AND 4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:05
L6	57	((tube NEAR8 solder \$3) SAME (wire OR lead)) AND ((in ADJ vivo) OR invivo OR implant\$6 OR transcutaneou\$3 OR subcutaneou\$3 OR cutaneou\$3) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:13

L7	57	((tube NEAR8 solder \$3) SAME (wire OR lead)) AND 6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:13
L8	0	(tube NEAR8 solder \$3 NEAR8 (circuit\$4 OR electronic OR substrate OR wafer OR semiconductor\$5)) AND (wire OR lead) AND ((in ADJ vivo) OR invivo OR implant \$6 OR transcutaneous \$3 OR subcutaneous \$3 OR cutaneous\$3) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:18
L9	8	(tube NEAR8 solder \$3 NEAR8 (circuit\$4 OR electronic OR substrate OR wafer OR semiconductor\$5)) AND (wire OR lead) AND ((in ADJ vivo) OR invivo OR implant \$6 OR transcutaneous \$3 OR subcutaneous \$3 OR cutaneous\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:19
L10	8	(tube NEAR8 solder \$3 NEAR8 (circuit\$4 OR electronic OR substrate OR wafer OR semiconductor\$5)) AND 9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:20
L11	24	((tube NEAR8 solder \$3) WITH (circuit\$4 OR electronic OR substrate OR wafer OR semiconductor\$5 OR electrode OR sensor OR detector)) AND (wire OR lead) AND ((in ADJ vivo) OR invivo OR implant \$6 OR transcutaneous \$3 OR subcutaneous \$3 OR cutaneous\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:22

L12	24	((tube NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR substrate OR wafer OR semiconductor\$5 OR electrode OR sensor OR detector)) AND 11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:23
L27	14	((((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconductor\$5 OR electrode)) SAME (wire OR lead)) AND ((in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:54
L28	14	((((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconductor\$5 OR electrode)) SAME (wire OR lead)) AND ((in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:57
L29	14	((((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconductor\$5 OR electrode)) SAME (wire OR lead)) AND 28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 14:57
L30	757	((((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconductor\$5 OR electrode)) SAME (wire OR lead))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:00

L31	28	(((tube OR cylinder) NEAR8 solder\$3) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconductor\$5 OR electrode)) SAME (wire OR lead)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:00
L32	1151	(((tube OR cylinder) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconductor\$5)) SAME (wire OR lead)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:17
L33	84	(((tube OR cylinder) NEAR5 conduct\$5) WITH (circuit\$4 OR electronic OR chip OR substrate OR wafer OR semiconductor\$5)) SAME (wire OR lead)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:18
L34	3	(((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND (sensor WITH (pressure OR catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:31

L35	3	((((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND 34	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:32
L36	11	((((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND (sensor WITH (pressure OR catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:33
L37	11	((((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND 36	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:33
L38	6	((((tube OR cylinder) NEAR5 (metal OR steel OR conduct\$5)) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ocls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:36
L39	20	((((tube OR cylinder) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ocls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:38

L40	60	((tube OR cylinder) WITH solder\$3) SAME (circuit\$4 OR chip OR microchip OR semiconductor\$5) SAME (lead OR wire OR conductor)) AND (("600"/\$) OR ("606"/\$) OR ("607"/\$)).ocls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:41
L41	147	((tube OR cylinder) NEAR8 conduct\$5) WITH solder\$3 WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5) SAME (lead OR wire OR conductor))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 15:54
L42	3	(US-20040152999-\$ or US-20030100839-\$).did. or (US-6712772-\$).did.	US-PGPUB; USPAT	OR	ON	2008/04/11 16:18
L43	3	hollow AND tube AND 42	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:19
L44	332	((tube OR cylinder) NEAR8 conduct\$5) WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND (sensor WITH (pressure OR catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:24
L45	332	((tube OR cylinder) NEAR8 conduct\$5) WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND 44	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:25

L46	194	((tube OR cylinder) NEAR8 (conducting OR conductive\$2)) WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND (sensor WITH (pressure OR catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:26
L47	194	((tube OR cylinder) NEAR8 (conducting OR conductive\$2)) WITH (circuit\$4 OR chip OR microchip OR semiconductor\$5)) AND 46	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:27
L48	12	("3778530" "4634638" "4970570" "5198885" "5329160" "5400489").PN. OR ("5508476").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/04/11 16:55
L49	2849	((circuit\$4 OR chip OR microchip OR semiconductor\$5) SAME sensor SAME (wire OR lead)) AND (sensor WITH pressure) AND (catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:58

L50	1170	((circuit\$4 OR chip OR microchip OR semiconduct\$5) SAME (sensor WITH pressure) SAME (wire OR lead)) AND (catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:59
L51	425	((circuit\$4 OR chip OR microchip OR semiconduct\$5) WITH (sensor WITH pressure)) SAME (wire OR lead)) AND (catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3) AND (("600"\$) OR ("606"/\$) OR ("607"/\$)).ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 17:21
L52	191	((circuit\$4 OR chip OR microchip OR semiconduct\$5) WITH (sensor WITH pressure)) SAME (wire OR lead)) AND (catheter OR (in ADJ vivo) OR invivo OR implant\$6 OR transcutaneous\$3 OR subcutaneous\$3 OR cutaneous\$3) AND (("600"\$) OR ("606"/\$) OR ("607"/\$)).ccls.	USPAT	OR	ON	2008/04/11 17:25
L53	191	((circuit\$4 OR chip OR microchip OR semiconduct\$5) WITH (sensor WITH pressure)) SAME (wire OR lead)) AND 52	USPAT	OR	ON	2008/04/11 17:25

L54	21	("2816997" "20020055764" "20060200200" "4407296" "4825876" "4873986" "5037488" "5094242" "5184619" "5211175" "5411538" "5522266" "5566680" "5658321" "5726624" "5969591" "5984711" "6006135" "6248083" "6712772" "6764472").PN.	US-PGPUB; USPAT	OR	OFF	2008/04/11 17:29
L55	206	("2532507" "2549049" "3090377" "3418853" "3447378" "3545275" "3553625" "3565056" "3628526" "3746087" "3847483" "3946724" "4114604" "4202339" "4399820" "4407296" "4421386" "4444498" "4467807" "4523279" "4554927" "4566456" "4623248" "4651741" "4697593" "4708143" "4727879" "4730389" "4730622" "4750495" "4791935" "4807629"	US-PGPUB; USPAT; USOCR	OR	ON	2008/04/11 17:38

"4807632" |
"4813421" |
"4815469" |
"4827933" |
"4830488" |
"4877032" |
"4903701" |
"4967755" |
"5005573" |
"5005587" |
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"5199428" |
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"5377524" |
"5411532" |
"5438987" |
"5490323" |
"5535752" |
"5556421" |
"5564434" |
"5593430" |
"5601611" |
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"5743267" |
"5755668" |
"5758652" |
"5788647" |
"5807265" |
"5836886" |
"B14467807" |
"H001114").FN. OR
("3831588" |
"5324326" |
"6019729" |
"6125290" |
"6125291").URPN.

L56	9	(US-6125291-\$ or US-6125290-\$ or US-6019729-\$ or US-5324326-\$ or US-3831588-\$ or US-6915162-\$ or US-5836886-\$ or US-5807265-\$ or US-4730389-\$).did.	USPAT	OR	ON	2008/04/11 17:59
L57	4	56 AND semiconductor\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	ON	2008/04/11 18:00

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